#### 12/22/2016 504152373

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4199046

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
WEN-CHUAN WANG	10/31/2012
BURN JENG LIN	10/31/2012
JAW-JUNG SHIN	10/31/2012
PEI-YI LIU	10/31/2012
SHY-JAY LIN	10/31/2012

#### **RECEIVING PARTY DATA**

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD
Street Address:	NO. 8, LI-HSIN RD. 6, SCIENCE-BASED INDUSTRIAL PARK
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK
City:	HSIN-CHU
State/Country:	TAIWAN
Postal Code:	300-77

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15389145

### **CORRESPONDENCE DATA**

Fax Number: (214)200-0853

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 214-651-5000

Email: ipdocketing@haynesboone.com

HAYNES AND BOONE. LLP IP SECTION **Correspondent Name:** 

2323 VICTORY AVENUE Address Line 1:

Address Line 2: SUITE 700

Address Line 4: DALLAS, TEXAS 75219

ATTORNEY DOCKET NUMBER:	24061.2964US05	
NAME OF SUBMITTER:	LINDA INGRAM	
SIGNATURE:	/Linda Ingram/	
DATE SIGNED:	12/22/2016	

**PATENT REEL: 040755 FRAME: 0977** 504152373

# **Total Attachments: 3**

source=2964US05\_Assignment#page1.tif

source=2964US05\_Assignment#page2.tif

source=2964US05\_Assignment#page3.tif

PATENT REEL: 040755 FRAME: 0978

Docket No.: 2012-0440 / 24061.2197

Customer No.: 42717

#### ASSIGNMENT

WHEREAS, we,

(1)	Wen-Chuan Wang	of	3F2, No. 133, Jiangong 1st Road, East District Hsinchu City 300, Taiwan R.O.C.
(2)	Shy-Jay Lin	of	No. 15, Alley 36, Lane 134, Yuanshan Road Jhudong Township, Hsinchu County 310 Taiwan R.O.C.
(3)	Pei-Yi Liu	of	No.62, Ln. 200, Zhuhe Road Changhua City, Changhua County 500, Taiwan R.O.C.
(4)	Jaw-Jung Shin	of	10F., No. 72-11, Lane 531, Sec. 1, Guangfu Road East District Hsinchu City 300, Taiwan R.O.C.
(5)	Burn Jeng Lin	of	153 Guang Fu Road Section 1, Lane 89, 1st Floor Hsinchu City, Taiwan R.O.C.

have invented certain improvements in

### GRID REFINEMENT METHOD

for which we have	filed a provisional application for Letters Patent of th	ie United States of
America, filed on	, and assigned U.S. Serial No.	; and

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd., ("TSMC"), No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu, Taiwan 300-77, Republic of China. is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said TSMC, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

-1-

R-2197 (2012-0440) - Assignment 10-30-12

PATENT REEL: 040755 FRAME: 0979

Docket No.: 2012-0440 / 24061.2197

Customer No.: 42717

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

Inventor	Name:
TITTO	ranno.

Wen-Chuan Wang

Residence Address:

3F.-2, No. 133, Jiangong 1st Road, East District

Hsinchu City 300, Taiwan R.O.C.

Dated: [0/3//30/2

Inventor Signature

Inventor Name:

Shy-Jay Lin

Residence Address:

No. 15, Alley 36, Lane 134, Yuanshan Road, Jhudong Township

Hsinchu County 310, Taiwan R.O.C.

Dated: 10/31/2012

Shy-Tay Lin
Inventor Signature

Docket No.: 2012-0440 / 24061.2197

Customer No.: 42717

Inventor Name:

Pei-Yi Liu

Residence Address:

No.62, Ln. 200, Zhuhe Road

Changhua City, Changhua County 500, Taiwan R.O.C.

Dated: 10/31 / >012

Inventor Signature

Inventor Name:

Jaw-Jung Shin

Residence Address:

10F., No. 72-11, Lane 531, Sec. 1, Guangfu Road, East District

Hsinchu City 300, Taiwan R.O.C.

Dated: 10(3//201

Inventor Signature

Inventor Name:

Burn Jeng Lin

Residence Address:

153 Guang Fu Road Section 1, Lane 89, 1st Floor

Hsinchu City, Taiwan R.O.C.

Dated: Of 31, 2012

Inventor Signature

R-2197 (2012-0440) - Assignment 10-30-12

**RECORDED: 12/22/2016** 

-3-